

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class* Form Type* Distribute Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

Supplier Information								
Company Name *	Company Unique ID	Unique ID Authority	Response Date*					
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 01:56 AM					
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *					
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					
Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *					
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					

Requester Item Number	Mfr Item Number		Mfr Item Name	Effective Dat		ffr Item Name Effective Date Version Manufacturing Site		Manufacturing Site		Weight*	UO	M	Unit Type
74LCX16373MTDX	74LCX163731	MTDX TS	SSOP-48 (NiPdAu) (G)				INTERNAL PENANG		0.191762	191762 g		Each	
Manufacturing Process Information													
Terminal Finis	h	Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature		ly Temperature	Max Time at Peak Temperature			No Reflow cycles					
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy		2			260 C		30 seconds			3			

* Required Field

 RoHS Material Composition Declaration
 Declaration Type * Custom

 RoHS Directive 2011/65/EU
 RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE)

This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.

The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.

Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.

RoHS Declaration * 1 - Item

1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. Exemption List Version EL-2011/534/EU

Declaration Signature

and Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name TSSOP-48 (NiPdAu) (G)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	2.300	Supplier		Silicon	2.300	7440-21-3	11994
Die Attach	Other Organic Materials	0.272	Supplier		Phenolic resin	0.071	54208-63-8	369
			Supplier		Silver	0.201	7440-22-4	1048
Encapsulation	Thermoplastics	111.100	Supplier		Carbon Black	1.111	1333-86-4	5794
			Supplier		Epoxy Resin	11.110	29690-82-2	57936
			Supplier		Silica, vitreous	98.879	60676-86-0	515635
Lead Frame	Copper & its alloys	70.195	Supplier		Copper	67.200	7440-50-8	350435
			Supplier		Magnesium	0.105	7439-95-4	548
			В	Nickel (external applications only)	Nickel	2.110	7440-02-0	11003
			Supplier		Silicon	0.456	7440-21-3	2378
			Supplier		Silver	0.324	7440-22-4	1690
Plating	Precious metals	6.705	Supplier		Gold	0.127	7440-57-5	662
			В	Nickel (external applications only)	Nickel	6.390	7440-02-0	33323
			Supplier		Palladium	0.188	7440-05-3	980
Wire Bond	Precious metals	1.190	Supplier		Gold	1.190	7440-57-5	6206